

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hideaki AWA</td> <td>05/10/2010</td> </tr> <tr> <td>Masato ARAI</td> <td>05/14/2010</td> </tr> <tr> <td>Hajime SHINOMIYA</td> <td>05/19/2010</td> </tr> </tbody> </table>		Name	Execution Date	Hideaki AWA	05/10/2010	Masato ARAI	05/14/2010	Hajime SHINOMIYA	05/19/2010
Name	Execution Date								
Hideaki AWA	05/10/2010								
Masato ARAI	05/14/2010								
Hajime SHINOMIYA	05/19/2010								
RECEIVING PARTY DATA									
Name:	SUMITOMO CHEMICAL COMPANY, LIMITED								
Street Address:	27-1, Shinkawa 2-chome, Chuo-ku								
City:	Tokyo								
State/Country:	JAPAN								
Postal Code:	104-8260								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12662122</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12662122				
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Application Number:	12662122								
CORRESPONDENCE DATA									
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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NAME OF SUBMITTER:	Patricia T. Hill								

Total Attachments: 2
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PATENT
REEL: 024582 FRAME: 0232

OP \$40.00 12662122

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s) Hideaki AWA
of Inventor(s) Masato ARAI
Hajime SHINOMIYA

Insert Name(s) the undersigned hereby sell(s) and assign(s) to
of Assignee(s) SUMITOMO CHEMICAL COMPANY, LIMITED
Address of 27-1, Shinkawa 2-chome, Chuo-ku, Tokyo 104-8260, Japan

Title of (hereinafter designated as the Assignee) the entire right, title and interest for the United States as
Invention defined in 35 USC 100, in the invention known as
METHOD FOR PRODUCING GRANULAR COMPOSITION

Date of for which an application for patent in the United States has been executed by the undersigned
Signing of on May 10, 2010, May 14, 2010 and May 19, 2010
Application

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 1030 15th Street, N.W., Suite 400 East, Washington, D.C. 20005-1503, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordal of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date <u>May 10, 2010</u>	<u>Hideaki Awa</u> Hideaki AWA
Date <u>May 14, 2010</u>	<u>Masato Arai</u> Masato ARAI
Date <u>May 19, 2010</u>	<u>Hajime Shinomiya</u> Hajime SHINOMIYA
Date _____	_____
Date _____	_____
Date _____	_____

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness <u>Yoshikazu Kimura</u>	Yoshikazu KIMURA
Witness <u>Toshiya Takahashi</u>	Toshiya TAKAHASHI

ACKNOWLEDGMENT

_____ } ss

This _____ day of _____, 20____, before me personally came the above-named _____ to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL

Official Signature

Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No.: 12/662,122

Filing Date: March 31, 2010

Applicant Reference Number: 557206

Attorney Docket No.: 2010_0454A